Power Amplifier, 3 W
28 - 30 GHz

Features
- High Gain: 24 dB
- P1dB: 34 dBm
- P3dB: 35 dBm
- IM3 Level: -18 dBc @ P_{OUT} 30 dBm/tone
- Power Added Efficiency: 23% @ P3dB
- Lead-Free 5 mm AQFN 32-lead Package
- RoHS* Compliant

Description
The MAAP-011289 is a 3 Watt, 4-stage power amplifier assembled in a lead-free 5 mm 32-lead AQFN plastic package. This power amplifier operates from 28 to 30 GHz and provides 24 dB of linear gain, 3 W saturated output power and 23% efficiency while biased at 6 V.

The MAAP-011289 can be used as a power amplifier stage or as a driver stage in higher power applications. This device is ideally suited for VSAT and 28 GHz PTP applications.

This product is fabricated using a GaAs pHEMT process which features full passivation for enhanced reliability.

Ordering Information

<table>
<thead>
<tr>
<th>Part Number</th>
<th>Package</th>
</tr>
</thead>
<tbody>
<tr>
<td>MAAP-011289-TR0500</td>
<td>500 piece reel</td>
</tr>
<tr>
<td>MAAP-011289-SMB</td>
<td>Sample Board</td>
</tr>
</tbody>
</table>

1. Reference Application Note M513 for reel size information.
2. All sample boards include 3 loose parts.

3. MACOM recommends connecting all No Connection (N/C) pins to ground.
4. The exposed pad centered on the package bottom must be connected to RF, DC and thermal ground.

---

MACOM Technology Solutions Inc. (MACOM) and its affiliates reserve the right to make changes to the product(s) or information contained herein without notice. Visit [www.macom.com](http://www.macom.com) for additional data sheets and product information.
Power Amplifier, 3 W
28 - 30 GHz

Electrical Specifications: Freq. = 28 & 30 GHz, T_A = +25°C, V_D = 6 V, Z_0 = 50 Ω

<table>
<thead>
<tr>
<th>Parameter</th>
<th>Test Conditions</th>
<th>Units</th>
<th>Min.</th>
<th>Typ.</th>
<th>Max.</th>
</tr>
</thead>
<tbody>
<tr>
<td>Gain</td>
<td>P_IN = -5 dBm, 28 GHz P_IN = -5 dBm, 30 GHz</td>
<td>dB</td>
<td>22</td>
<td>26</td>
<td>—</td>
</tr>
<tr>
<td></td>
<td>P_IN = 11 dBm, 28 GHz P_IN = 13 dBm, 30 GHz</td>
<td>dBm</td>
<td>33</td>
<td>34.0</td>
<td>—</td>
</tr>
<tr>
<td>IM3 Level</td>
<td>P_OUT = 30 dBm / tone</td>
<td>dBC</td>
<td>—</td>
<td>-18</td>
<td>—</td>
</tr>
<tr>
<td>Power Added Efficiency</td>
<td>P_IN = 11 &amp; 13 dBm</td>
<td>%</td>
<td>—</td>
<td>23</td>
<td>—</td>
</tr>
<tr>
<td>Input Return Loss</td>
<td>P_IN = -20 dBm</td>
<td>dB</td>
<td>—</td>
<td>14</td>
<td>—</td>
</tr>
<tr>
<td>Output Return Loss</td>
<td>P_IN = -20 dBm</td>
<td>dB</td>
<td>—</td>
<td>14</td>
<td>—</td>
</tr>
<tr>
<td>Quiescent Current</td>
<td>I_DD (see bias conditions, page 4)</td>
<td>mA</td>
<td>—</td>
<td>1500</td>
<td>—</td>
</tr>
<tr>
<td>Current</td>
<td>P_IN = 11 &amp; 13 dBm</td>
<td>mA</td>
<td>—</td>
<td>2300</td>
<td>—</td>
</tr>
</tbody>
</table>

Maximum Operating Ratings

<table>
<thead>
<tr>
<th>Parameter</th>
<th>Rating</th>
</tr>
</thead>
<tbody>
<tr>
<td>Input Power, Pulsed</td>
<td>16 dBm</td>
</tr>
<tr>
<td>Junction Temperature^5,6</td>
<td>+160°C</td>
</tr>
<tr>
<td>Operating Temperature</td>
<td>-40°C to +85°C</td>
</tr>
</tbody>
</table>

Handling Procedures
Please observe the following precautions to avoid damage:

Static Sensitivity
These electronic devices are sensitive to electrostatic discharge (ESD) and can be damaged by static electricity. Proper ESD control techniques should be used when handling these HBM Class 1A devices.

MACOM Technology Solutions Inc. (MACOM) and its affiliates reserve the right to make changes to the product(s) or information contained herein without notice.
Visit www.macom.com for additional data sheets and product information.

For further information and support please visit: https://www.macom.com/support
Sample Board Layout

Application Schematic

Parts List

<table>
<thead>
<tr>
<th>Part</th>
<th>Value</th>
<th>Case Style</th>
</tr>
</thead>
<tbody>
<tr>
<td>C1 - C4</td>
<td>0.01 µF</td>
<td>0402</td>
</tr>
<tr>
<td>C5 - C8</td>
<td>1 µF</td>
<td>0603</td>
</tr>
<tr>
<td>R1 - R4</td>
<td>10 Ω</td>
<td>0402</td>
</tr>
</tbody>
</table>

Sample Board Material Specifications

Top Layer: 1/2 oz Copper Cladding, 0.017 mm thickness
Dielectric Layer: Rogers RO4003C 0.203 mm thickness
Bottom Layer: 1/2 oz Copper Cladding, 0.017 mm thickness
Finished overall thickness: 0.238 mm

Note: VD4 must be biased from both sides.
Recommended PCB Layout Detail:
RF input and output pre-matching circuit patterns are designed to compensate packaging effects. Transmission line dimensions apply to a PCB with 0.203 mm thick Rogers RO4003C laminate dielectric. Performance curves shown in this data sheet were measured with these circuit patterns.

Input Tuning:

Output Tuning:

Biasing Conditions
Recommended biasing conditions are $V_D = 6\, \text{V}$, $I_{DQ} = 1500\, \text{mA}$ (controlled with $V_G$). The drain bias voltage range is 3 to 6 V, and the quiescent drain current biasing range is 1300 to 1700 mA.

$V_G$ pins 10 and 11 are connected internally; choose either pin for layout convenience. Muting can be accomplished by setting the $V_G$ to the pinched off voltage ($V_G = -2\, \text{V}$).

$V_D$ bias must be applied to $V_{D1}$, $V_{D2}$, $V_{D3}$, and $V_{D4}$ pins. $V_{D3}$ pins 27 and 28 are connected internally: choose either pin for layout convenience. Two $V_{D4}$ pins 15 and 26 (not connected internally) are required for current symmetry.

Operating the MAAP-011289

**Turn-on**
1. Apply $V_G$ (-1.5 V).
2. Apply $V_D$ (6.0 V typical).
3. Set $I_{DQ}$ by adjusting $V_G$ more positive (typically -0.9 to -1.0 V for $I_{DQ} = 1500\, \text{mA}$).
4. Apply $RF_{IN}$ signal.

**Turn-off**
1. Remove $RF_{IN}$ signal.
2. Decrease $V_G$ to -1.5 V.
3. Decrease $V_D$ to 0 V.
Typical Performance Curves

Small Signal Gain vs. Frequency over Temperature

-28.0 28.5 29.0 29.5 30.0

Small Signal Gain vs. Frequency over Bias Voltage

-28.0 28.5 29.0 29.5 30.0

Input Return Loss vs. Frequency over Temperature

-28.0 28.5 29.0 29.5 30.0

Input Return Loss vs. Frequency over Bias Voltage

-28.0 28.5 29.0 29.5 30.0

Output Return Loss vs. Frequency over Temperature

-28.0 28.5 29.0 29.5 30.0

Output Return Loss vs. Frequency over Bias Voltage

-28.0 28.5 29.0 29.5 30.0

MACOM Technology Solutions Inc. (MACOM) and its affiliates reserve the right to make changes to the product(s) or information contained herein without notice. Visit www.macom.com for additional data sheets and product information.

For further information and support please visit: https://www.macom.com/support
Power Amplifier, 3 W
28 - 30 GHz

Typical Performance Curves

**P3dB vs. Frequency over Temperature**

![P3dB vs. Frequency over Temperature graph](image1)

**P3dB vs. Frequency over Bias Voltage**

![P3dB vs. Frequency over Bias Voltage graph](image2)

**P1dB vs. Frequency over Temperature**

![P1dB vs. Frequency over Temperature graph](image3)

**P1dB vs. Frequency over Bias Voltage**

![P1dB vs. Frequency over Bias Voltage graph](image4)
Power Amplifier, 3 W
28 - 30 GHz

Typical Performance Curves

**Output IP3 over Temperature** ($P_{\text{OUT}} = 30$ dBm / Tone)

**Output IP3 over Bias Voltage** ($P_{\text{OUT}} = 30$ dBm / Tone)

**IM3 over Temperature** ($P_{\text{OUT}} = 30$ dBm / Tone)

**IM3 over Bias Voltage** ($P_{\text{OUT}} = 30$ dBm / Tone)
Typical Performance Curves

**P1dB, P3dB vs. Frequency**

![Graph showing P1dB, P3dB vs. Frequency](image)

**Gain and PAE @ P3dB vs. Frequency**

![Graph showing Gain and PAE vs. Frequency](image)

**IM3 vs. Output Power**

![Graph showing IM3 vs. Output Power](image)

**Output IP3 vs. Output Power**

![Graph showing Output IP3 vs. Output Power](image)
Typical Performance Curves

Output Power vs. Input Power

PAE vs. Input Power

Bias Current vs. Input Power

Quiescent Drain Current vs. Temperature
Lead-Free 5 mm AQFN 32-Lead†

† Reference Application Note S2083 for lead-free solder reflow recommendations.
Meets JEDEC moisture sensitivity level 3 requirements.
Plating is NiPdAu.